Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	30	fuller.in. and substrate.ti.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/01/04 13:39
L2	14	("4612083" | "5229550" | "5706178" | "5902118" | "5956843" | "6026564" | "6054761" | "6199273" | "6204456" | "6208525" | "6388204" | "6459047" | "6479093" | "6630630").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 13:46
L3	13	("4612083" | "5229550" | "5706178" | "5902118" | "5956843" | "6026564" | "6054761" | "6199273" | "6204456" | "6208525" | "6388204" | "6459047" | "6479093").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 13:48
L5	5259	(print$3 wiring circuit circuitiz$3) near4 (board substrate wafer) with (hole opening cavity via window aperture) and (hole opening cavity via window aperture) with (conduct$3 metal$3) with (filling fill filled dispens$3 deposit$3) and (laminat$3 bonding bond)	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 15:45
L6	452	"29"/$.ccls. and "174"/$ and 5	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 14:27
L7	372	6 and (first second) with (board substrate wafer)	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 14:28

L8	41	("20020050402" | "4876120" | "5218030" | "5258325" | "5346747" | "5352745" | "5426522" | "5477612" | "5517751" | "5640761" | "5677045" | "5819403" | "5821457" | "5822850" | "5824950" | "5830542" | "5950306" | "6078102" | "6092280" | "6108903" | "6114005" | "6154940" | "6163957" | "6243946" | "6274242" | "6323436" | "6329603" | "6351393" | "6352782" | "6355504" | "6373717" | "6465742" | "6580031" | "6581280" | "6673190" | "6708404" | "6722031" | "6745464" | "6748652" | "6764748" | "6774316").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 15:32
L9	5	("4302501" | "4383363" | "4967314" | "5346750" | "5652042").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 15:34
L10	222	(first second additional multiple) with (print$3 wiring circuit circuitiz$3) near4 (board substrate wafer) with (hole opening cavity via window aperture) and (hole opening cavity via window aperture) with (conduct$3 metal$3) with (filling fill filled dispens$3 deposit$3) and (laminat$3 bonding bond) and partial$2 with (filling fill filled dispens$3 deposit$3)	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 15:48
L11	240	(first second additional multiple) with (print$3 wiring circuit circuitiz$3) near4 (board substrate wafer) with (hole opening cavity via window aperture) and (hole opening cavity via window aperture) with (conduct$3 metal$3) with (filling fill filled dispens$3 deposit$3) and (laminat$3 bonding bond) and (partly partial$2) with (filling fill filled dispens$3 deposit$3)	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 16:33

| L12 | 44 | ("3915729" \| "4176602" \| "4391742" \| "4619715" \| "4789411" \| "4859268" \| "5062896" \| "5064482" \| "5088189" \| "5128746" \| "5150195" \| "5156771" \| "5204025" \| "5328522" \| "5334261" \| "5346558" \| "5360672" \| "5376403" \| "5382300" \| "5397511" \| "5405044" \| "5417897" \| "5429785" \| "5431854" \| "5450290" \| "5487852" \| "5628926" \| "5640761" \| "5641996" \| "5703202" \| "5714803" \| "5744285" \| "5762259" \| "5783867" \| "5822856" \| "5825629" \| "5844320" \| "5851311" \| "5921462" \| "5985043" \| "5988487" \| "6054761" \| "6089151" \| "6165885").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2006/01/04 15:56 |
| L13 | 68 | ("3077511" \| "3214827" \| "3316618" \| "3316619" \| "3509270" \| "3541222" \| "3546775" \| "3561110" \| "3606677" \| "3616532" \| "3739469" \| "3775844" \| "3795037" \| "3795047" \| "3829601" \| "3852877" \| "3859711" \| "3862790" \| "4024629" \| "4211603" \| "4216350" \| "4237606" \| "4249032" \| "4383363" \| "4394712" \| "4417392" \| "4452847" \| "4479991" \| "4511757" \| "4641425" \| "4642889" \| "4677254" \| "4712161" \| "4720470" \| "4729809" \| "4740414" \| "4755911" \| "4788766" \| "4793814" \| "4817280" \| "4868980" \| "4915795" \| "4935584" \| "4954878" \| "4970106" \| "5001605" \| "5046238" \| "5048178" \| "5056216" \| "5069628" \| "5072075" \| "5089880" \| "5121299" \| "5128831" \| "5129142" \| "5140745" \| "5147210" \| "5282312").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2006/01/04 16:00 |

L14	41	("3077511" | "3214827" | "3316618" | "3509270" | "3541222" | "3546775" | "3606677" | "3616532" | "3739469" | "3775844" | "3795037" | "3795047" | "3829601" | "3859711" | "3862790" | "4024629" | "4211603" | "4216350" | "4249302" | "4383363" | "4642889" | "4712161" | "4729809" | "4788766" | "4793814" | "4935584" | "4954878" | "5046238" | "5069628" | "5072075" | "5089880" | "5129142" | "5140745").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 16:06
L15	106	(print$3 wiring circuit circuitiz$3) near4 (board substrate wafer) with (hole opening cavity via window aperture) and (hole opening cavity via window aperture) with (conduct$3 metal$3) with (filling fill filled dispens$3 deposit$3) and (laminat$3 bonding bond) same (partly partial$2) near3 (filling fill filled dispens$3 deposit$3)	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 16:34
L16	26	("3148310").URPN.	USPAT	OR	ON	2006/01/04 16:39
L17	54	("3077511" | "3214827" | "3316618" | "3316619" | "3509270" | "3541222" | "3546775" | "3561110" | "3606677" | "3616532" | "3739469" | "3775844" | "3795037" | "3795047" | "3829601" | "3859711" | "3862790" | "4024629" | "4211603" | "4216350" | "4249032" | "4249302" | "4383363" | "4394712" | "4452847" | "4479991" | "4511757" | "4642889" | "4712161" | "4729809" | "4740411" | "4755911" | "4788766" | "4793814" | "4935584" | "4954878" | "4970106" | "5089880" | "5121299" | "5128831" | "5129142" | "5140745" | "5224265" | "5232598").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 16:41

L18	13	("3676566" | "3934334" | "3984244" | "4368503" | "4394712" | "4670770" | "4803450" | "4830264" | "4845311" | "4854038" | "4864722" | "4868350" | "4908933").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 16:43
L19	43	("4803450").URPN.	USPAT	OR	ON	2006/01/04 16:44
L20	62	("5129142").URPN.	USPAT	OR	ON	2006/01/04 16:47
L21	13	("3676566" | "3934334" | "3984244" | "4368503" | "4394712" | "4670770" | "4803450" | "4830264" | "4845311" | "4854038" | "4864722" | "4868350" | "4908933").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 17:19
L22	1	"5280414".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 18:07
L23	6	("4612083"|"5902118"|"5956843" |"6388204"|"6459047"|"6479093").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 18:07